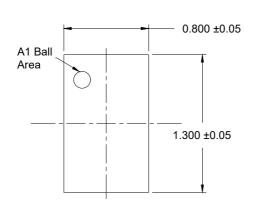
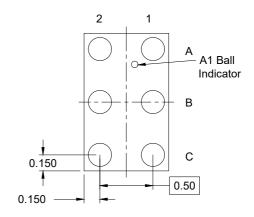




Package Code: AHR6D1

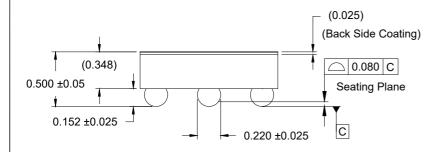
6-WLCSP 0.800 x 1.300 x 0.500 mm Body, 0.5mm Pitch PSC-4779-01, Revision: 04, Date Created: Aug 5, 2022



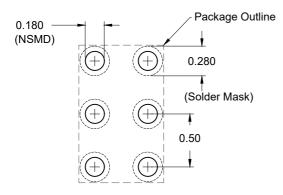


**TOP VIEW** 

**BOTTOM VIEW** 



## SIDE VIEW



RECOMMENDED LAND PATTERN (PCB Top View, NSMD Design)

## NOTES:

- 1. JEDEC compatible.
- 2. All dimensions are in mm and angles are in degrees.
- 3. Use ±0.05 mm for the non-toleranced dimensions.
- 4. Numbers in ( ) are for references only.
- 5. Pre-reflow solder ball diameter is Ø0.200 mm.
- 6. UBM diameter is Ø0.200 mm.